

SPECIFICATIONS DE CONTROLE DES COMPOSANTS

BGA - CSP

Coplanarity (4)	Ball Presence	Warpage (6)	Ball Height (7)	Ball offset	Grid-to-package offset	Ball pitch	Body width Body height	Ball width	Ball quality	Contrast

GULL WING

Lead coplanarity	Body standoff	Lead pitch Lead offset Lead skew	Half span Lead length dev. Lead width	Terminal dimensions	Foot angle (2)	Lead sweep	Lead slant	Burr (5)

J-LEAD

Lead coplanarity	Body standoff	Lead pitch Lead offset Lead skew	Lead length dev.	Lead sweep	Lead slant